

PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.		AMS/19/11525
1.3 Title of PCI		New Test location for products assembled in HTSSOP16 package
1.4 Product Category		See product list
1.5 Issue date		2019-07-31

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Marcello SAN BIAGIO
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	Test & Finishing : Subcontractor TSHT China

4. Description of change

	Old	New
4.1 Description	Assembly site : Subcontractor Amkor Philippines Test & Finishing : ST Muar	Assembly site : Subcontractor Amkor Philippines Test & Finishing : Subcontractor TSHT China
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The purpose of the introduction of TSHT for Test & Finishing activities is to further improve the rationalization of our manufacturing assets, provide a better support to our customers by enhancing the manufacturing process for higher volume production.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	New finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2019-05-15
7.2 Intended start of delivery	2019-09-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	11525 PCI_TSHT_QUALIFICATION.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-07-31

9. Attachments (additional documentations)

11525 Public product.pdf
11525 PCI_TSHT_QUALIFICATION.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L7987	
	L7987L	
	L7987LTR	
	L7987TR	

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Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : New Test location for products assembled in HTSSOP16 package

PCI Reference : AMS/19/11525

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

L7987TR	L7987L	L7987
L7987LTR		



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